



Flash Memory Summit

# NVMe Over Fabrics: Scaling Up With The Storage Performance Development Kit

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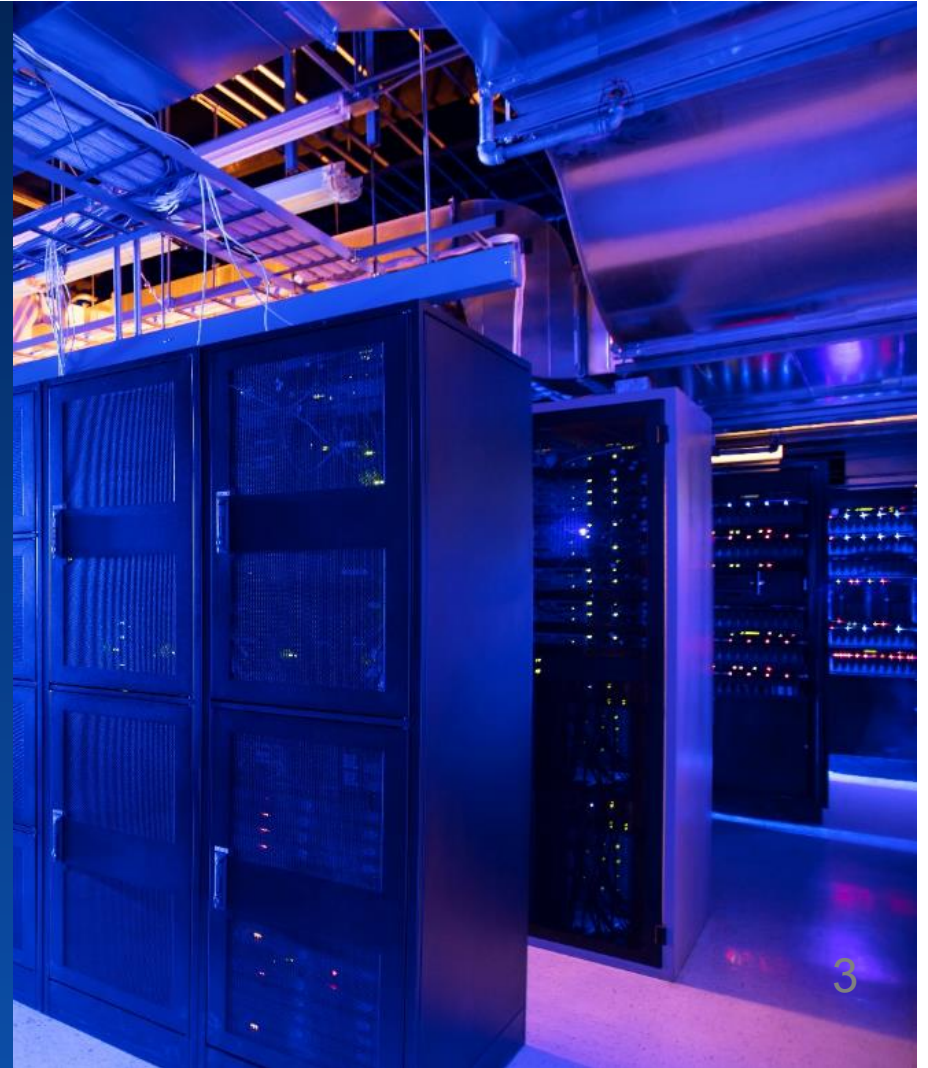
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# Agenda

- Design Overview
- Benchmarking
  - Connections
  - CPU cores





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# Design Overview

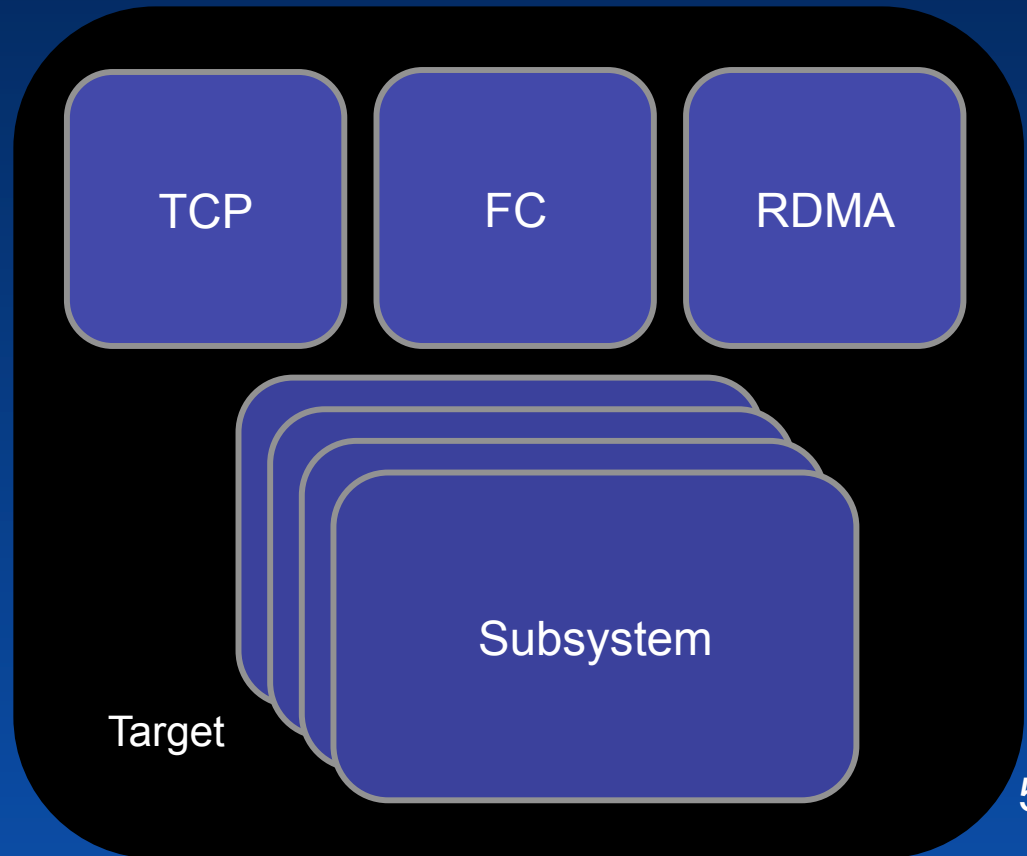


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# NVMe-oF Primitives

- `spdk_nvme_tgt`
  - `spdk_nvme_subsystem`
  - `spdk_nvme_transport`

Global Scope

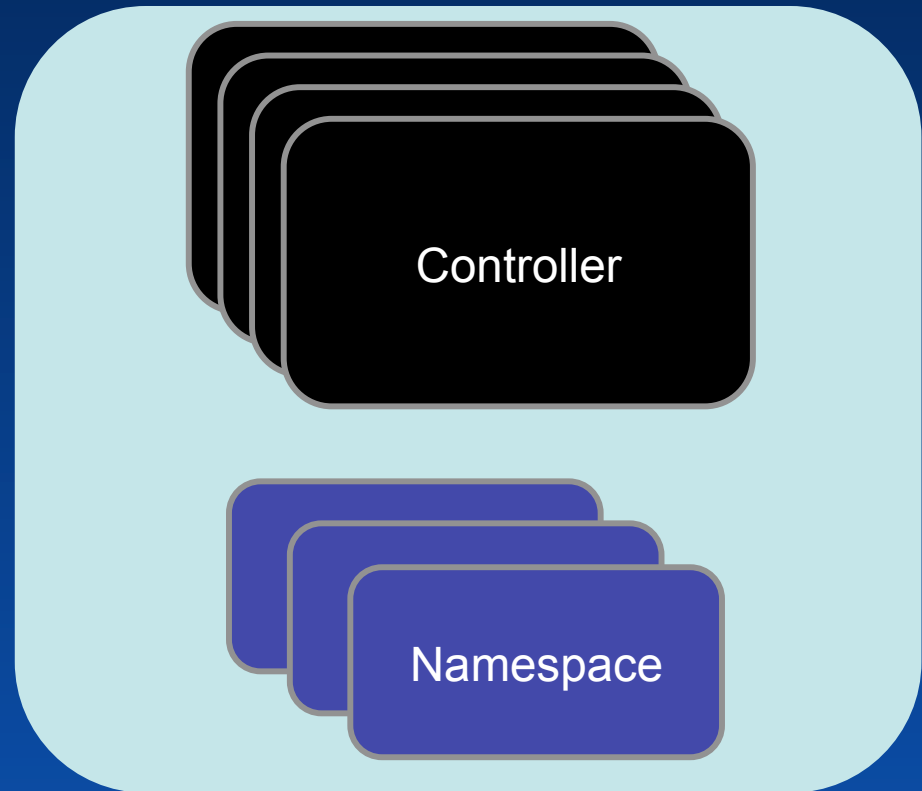




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# NVMe-oF Subsystems

- Subsystems are **global**
- Subsystems have states
  - Inactive
  - Paused
  - Active
- `spdk_nvme_subsystem` may only be modified while not in the active state.
- Contains controllers and namespaces



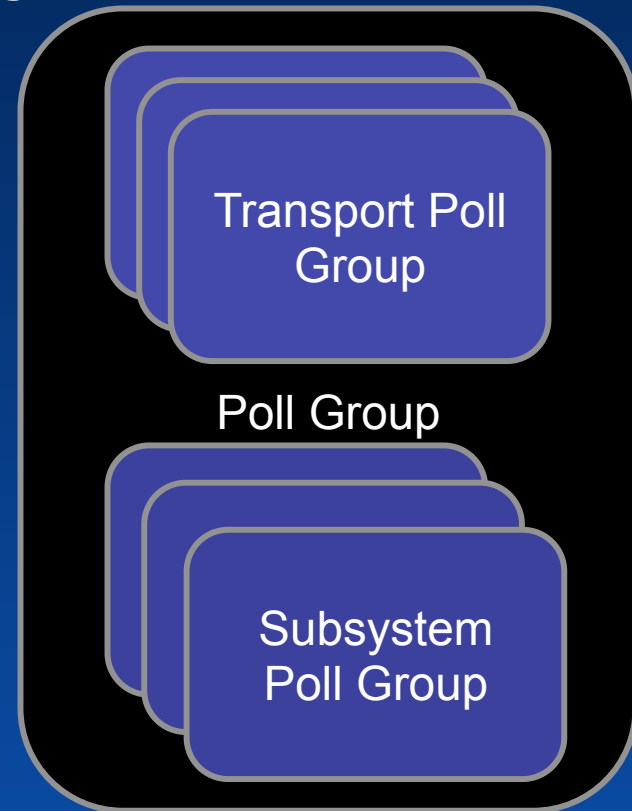


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# NVMe-oF Primitives

- `spdk_nvme_poll_group`
  - `spdk_nvme_subsystem_poll_group`
  - `spdk_nvme_transport_poll_group`

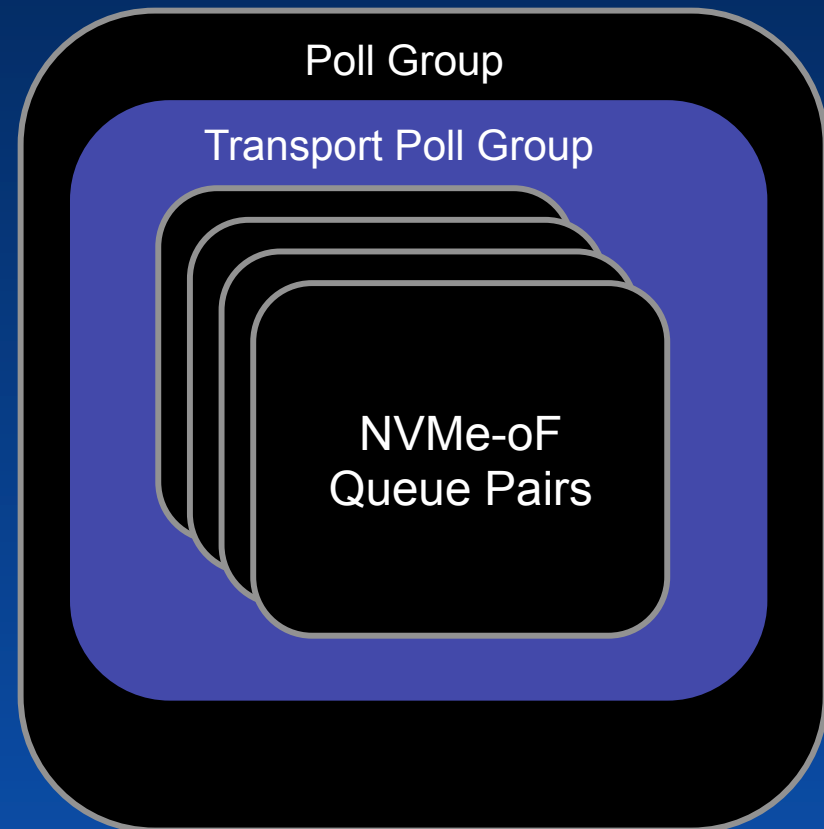
Per-thread Scope





# NVMe-oF Transport Poll Groups

- Per-thread collection of transport data
- Uses a transport-specific mechanism to efficiently poll the group
  - RDMA: Shared completion queue
  - FC: Shared hardware queue pair
  - TCP: epoll/kqueue
- The queue pairs are not necessarily related to one another







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# NVMe-oF Subsystem Poll Groups

- Per-thread collection of subsystem data
- Contains thread-unique I/O channels for each namespace in the subsystem.
- Think of an I/O channel as an NVMe queue pair for the local device.





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# Accepting a New Connection

`spdk_nvmf_tgt_accept()`

`new_qpair_fn(qpair)`

`spdk_nvmf_poll_group_add(qpair)`

When does a queue pair identify which subsystem it belongs to?



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# Performing an I/O

- No Locks!
- Touches only thread-local data (cache friendly)!
- Lookups are all array math!

Poll

Parse

Look Up

Submit

Poll group checks for incoming requests. Request is associated with a subsystem and targets a namespace. Look up I/O channel for subsystem + namespace in subsystem poll group. Use I/O channel to submit I/O to bdev layer.



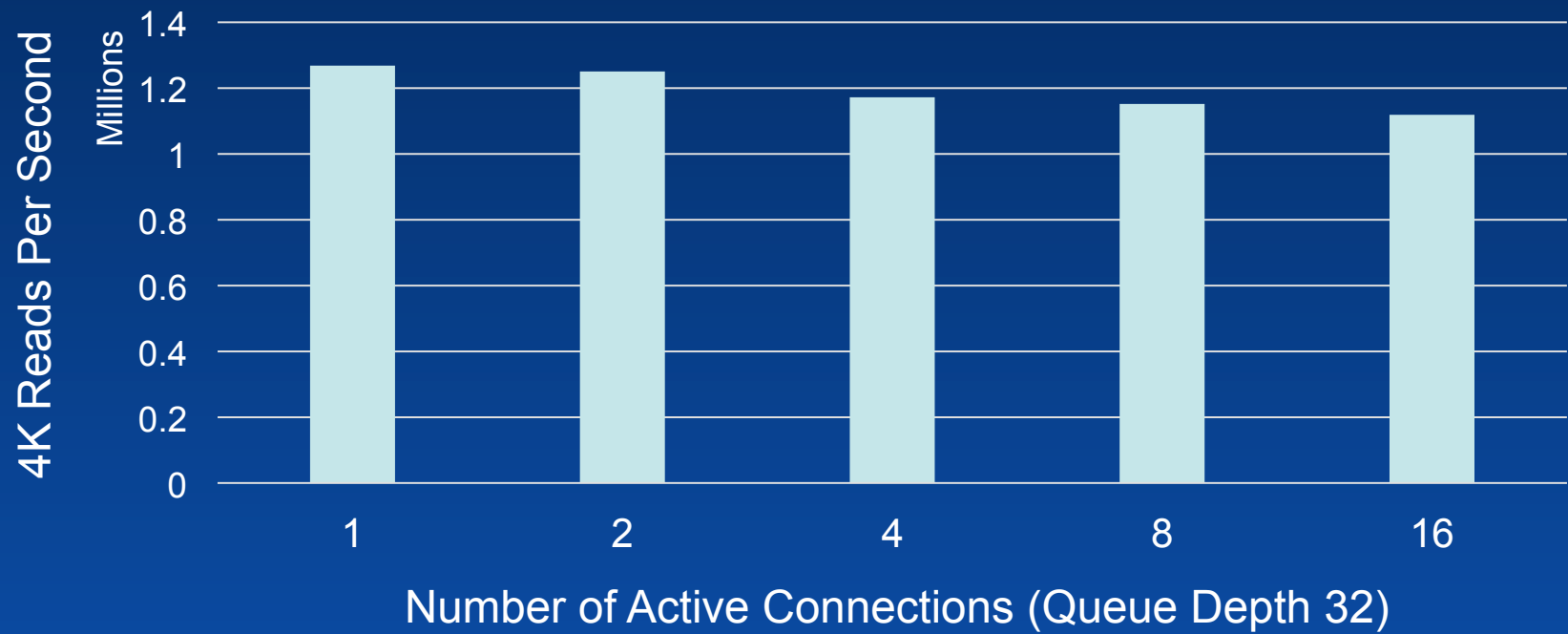
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# Benchmarks



# Scaling: Active Connections

Single Core

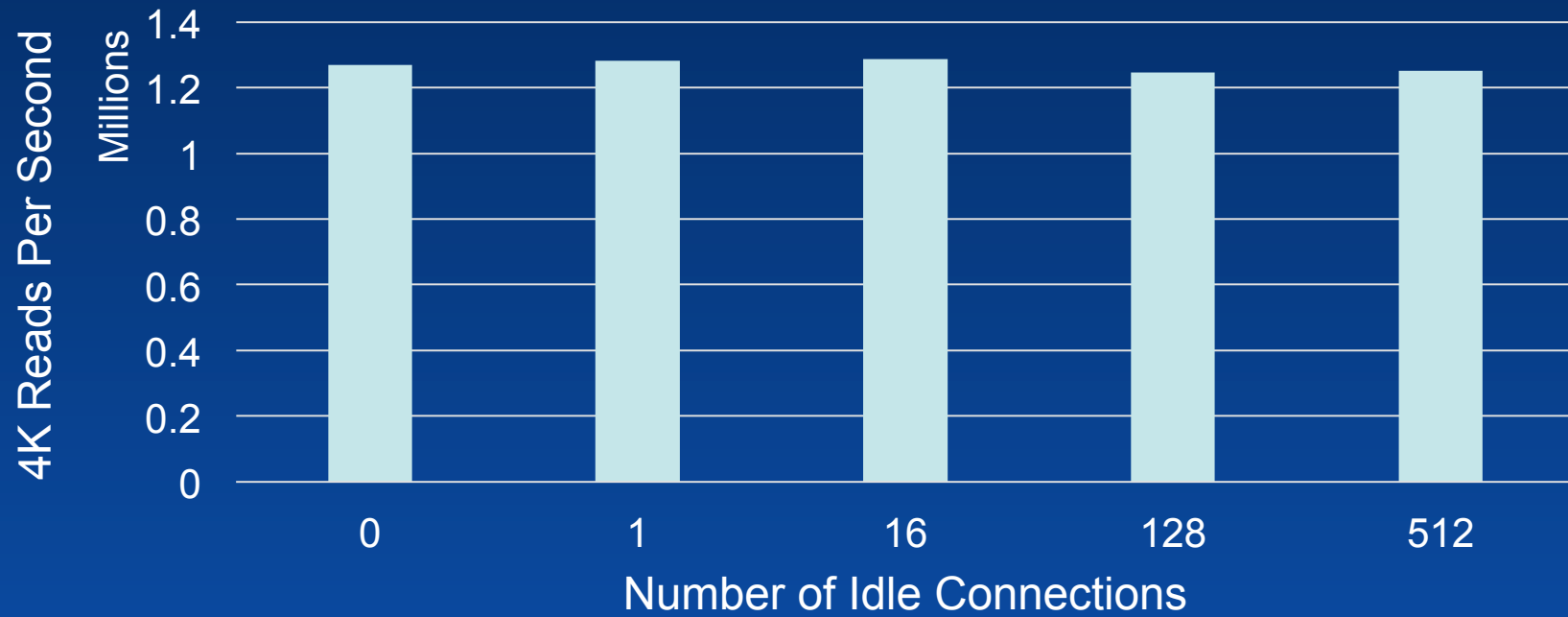


System Configuration: 2x Intel® Xeon® Platinum 8180 CPU @ 2.50 GHz, Intel® Speed Step enabled, Intel® Turbo Boost Technology enabled, 4x 2GB DDR4 2666 MT/s, 1 DIMM per channel, Ubuntu\* Linux 17.10, Linux kernel 4.13.0, SPDK 18.04, DPDK 18.01, Mellanox® ConnectX-4 MT27700



# Scaling: Idle Connections

Single Core

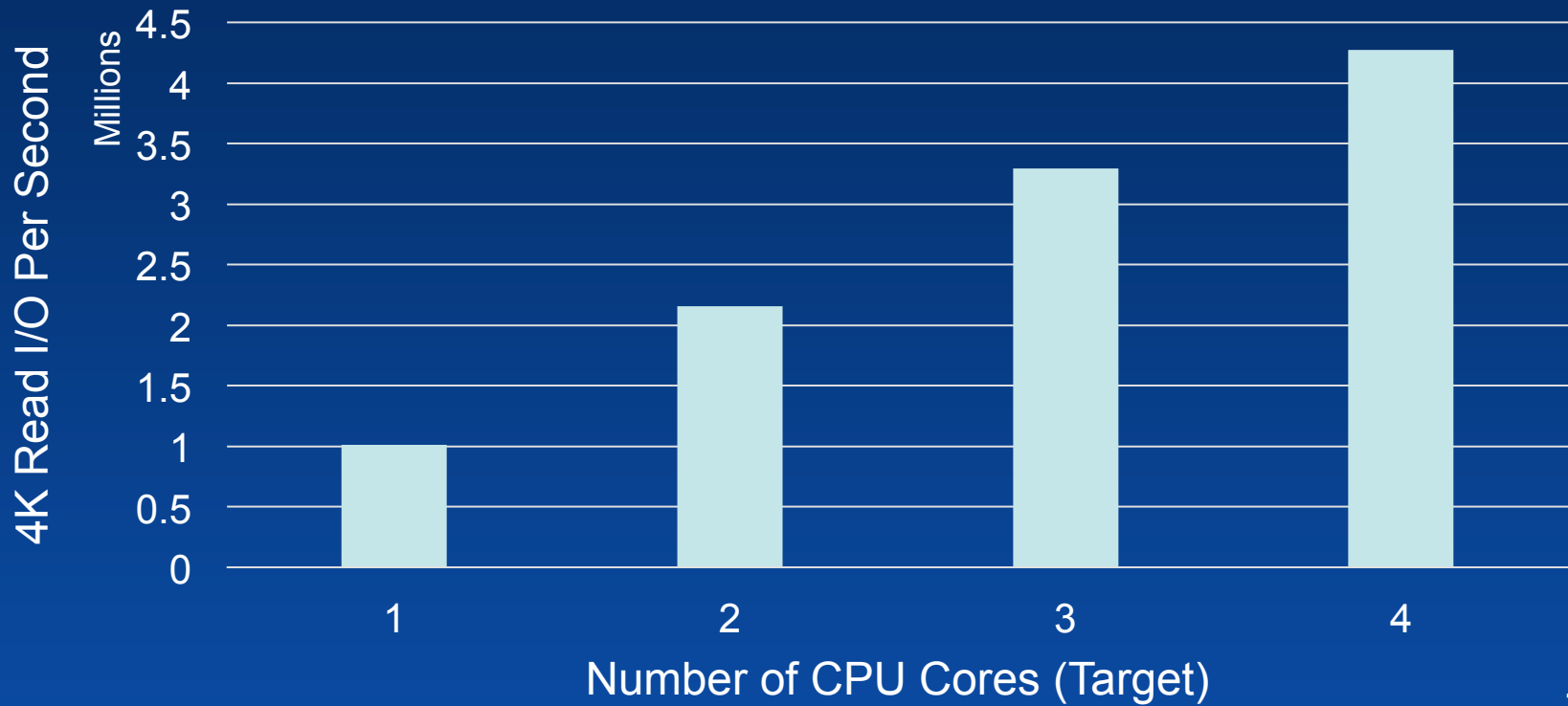


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# Performance vs Number of CPU Cores



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Thank You